

STEREO AMPLIFIER

- WIDE SUPPLY VOLTAGE RANGE: 3 TO 30V
- SINGLE OR SPLIT SUPPLY OPERATION
- VERY LOW CURRENT CONSUMPTION:
0.8mA
- VERY LOW DISTORTION: 0.03% TYPICAL

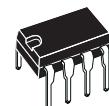
DESCRIPTION

The TDA2320A is a stereo class A preamplifier intended for application in portable cassette players and high quality audio systems.
 The TDA2320A is a monolithic integrated circuit in a 8 lead plastic dip.

ORDER CODE

Part Number	Temperature Range	Package	
		N	D
TDA2320A	-40°C, +105°C	•	•
Example : TDA2320AN			

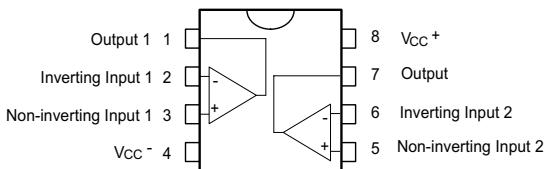
N = Dual in Line Package (DIP)



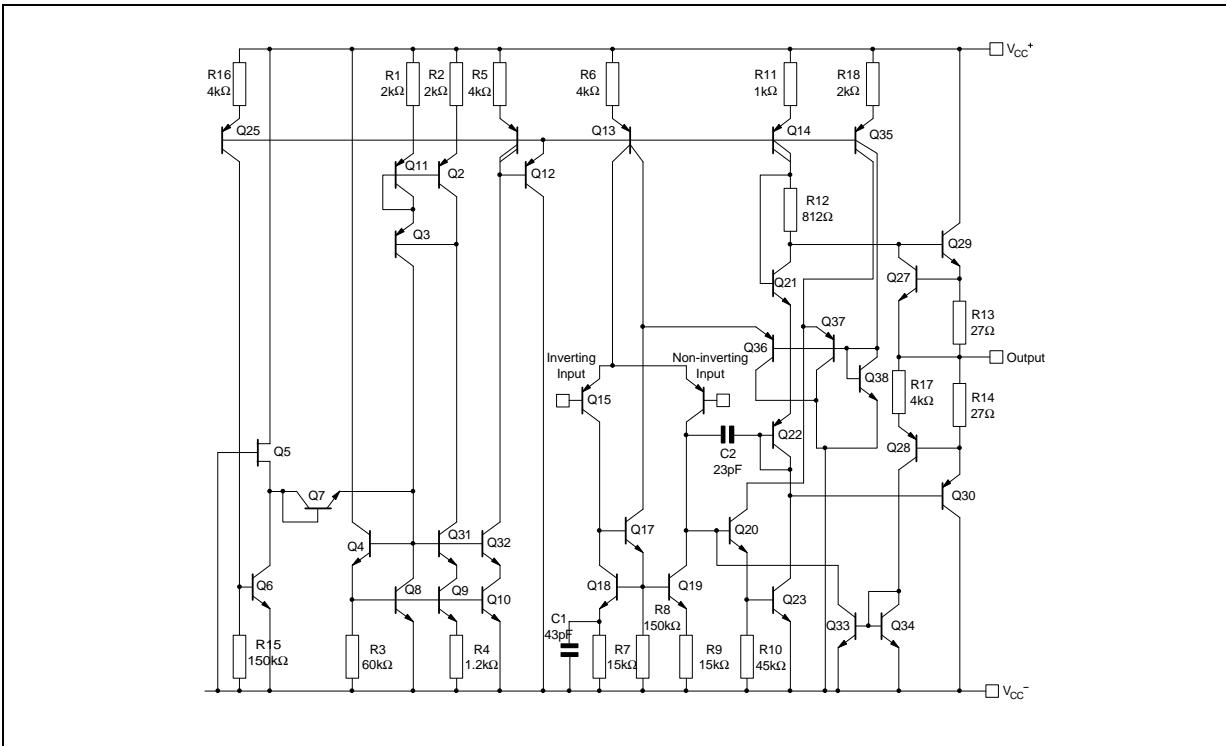
N
DIP8
(Plastic Package)



D
SO8
(Plastic Micropackage)

PIN CONNECTIONS (top view)

SCHEMATIC DIAGRAM (1/2 TDA2320A)



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	36	V
P_{tot}	Total Power Dissipation at $T_{amb} = 70^{\circ}\text{C}$ ¹⁾	400	mW
T_{stg}, T_j	Storage and Junction Temperature	-40 to 150	°C

1. Power dissipation must be considered to ensure maximum junction temperature (T_j) is not exceeded.

ELECTRICAL CHARACTERISTICS $V_{CC} = 15V$, $T_{amb} = 25^{\circ}C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{CC}	Supply Voltage	3		30	V
I_{CC}	Supply Current		0.8	2	mA
I_{ib}	Input Bias Current		150	500	mV
V_{io}	Input Offset Voltage $R_s \leq 10k\Omega$		1	5	mV
I_{io}	Input Offset Current		10	50	nA
A_{vd}	Open Loop Voltage Gain $V_{CC} = 15V$ $f = 333Hz$ $f = 1kHz$ $f = 10kHz$ $f = 1kHz$		80 70 50 70		dB
V_{opp}	Output Voltage Swing ($f = 1kHz$, $R_L = 600\Omega$) $V_{CC} = 15V$ $V_{CC} = 4.5V$		13 2.5		V
GBP	Gain-bandwidth Product $f = 200kHz$	1.5	2.5		MHz
FPB	Power Bandwidth $V_o = 5V_{pp}$, THD = 1%	40	70		kHz
SR	Slew Rate (see note 1)	1	1.6		V/ μ s
e_n	Equivalent Input Noise Voltage Curve A $R_s = 50\Omega$ $R_s = 600\Omega$ $R_s = 5k\Omega$ B = 22Hz to 22kHz $R_s = 50\Omega$ $R_s = 600\Omega$ $R_s = 5k\Omega$ $f = 1kHz$ $R_s = 600\Omega$		1 1.1 1.5 1.3 1.5 2 9		μ V μ V μ V μ V μ V μ V nV/ \sqrt{Hz}
THD	Distortion ($V_o = 2V$, $A_v = 20dB$) $f = 1kHz$ $f = 10kHz$		0.03 0.08		%
PSRR	Power Supply Rejection Ratio $f = 100Hz$		80		dB
V_{o1}/V_{o2}	Channel Separation $f = 1kHz$		100		dB

Figure 1 : Supply Current versus Supply Voltage

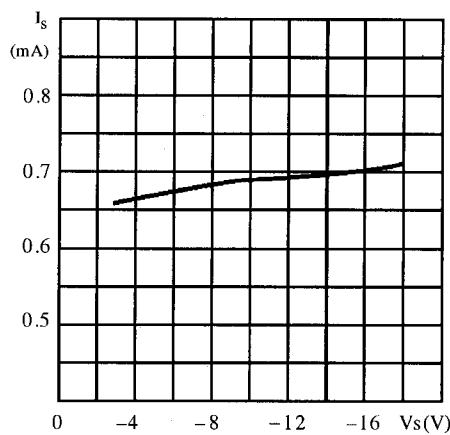


Figure 2 : Supply Current versus Ambient Temperature

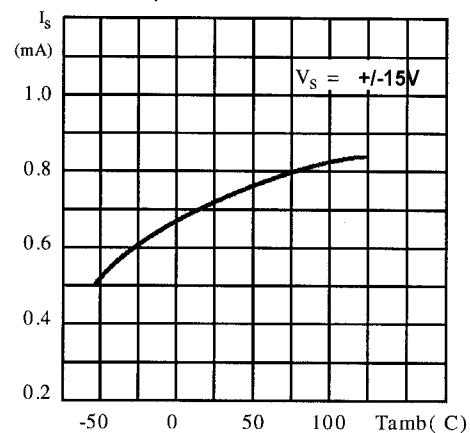


Figure 3 : Output Short Circuit Current versus Ambient Temperature

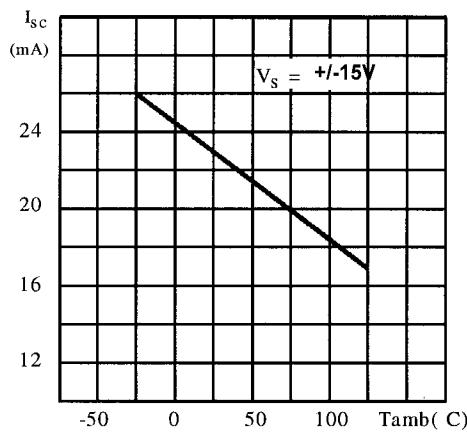


Figure 4 : Open Loop Frequency and Phase Response

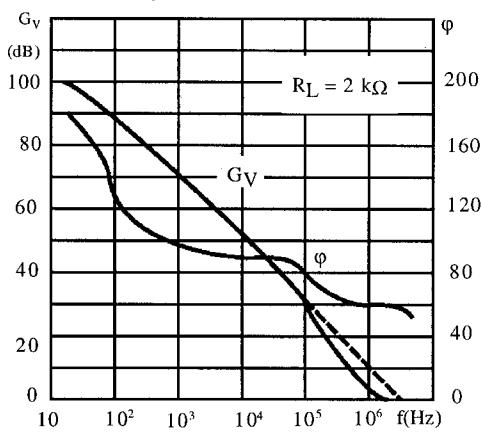


Figure 5 : Output Loop Gain versus Ambient Temperature

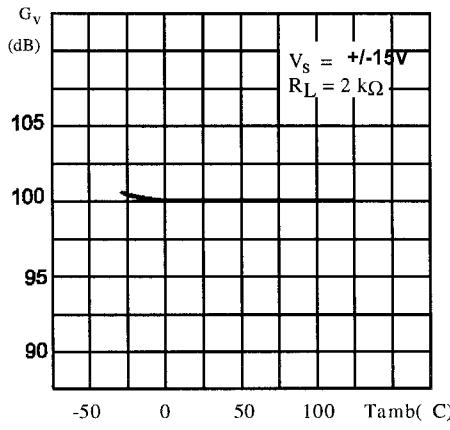


Figure 6 : Supply Voltage Rejection versus Frequency

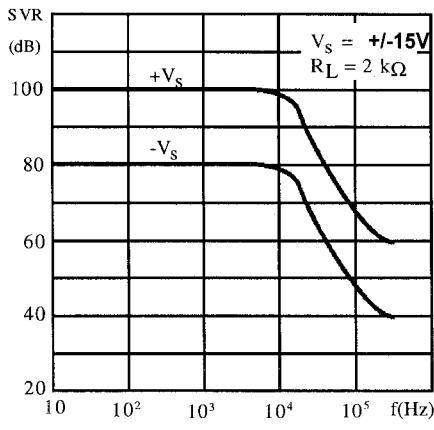


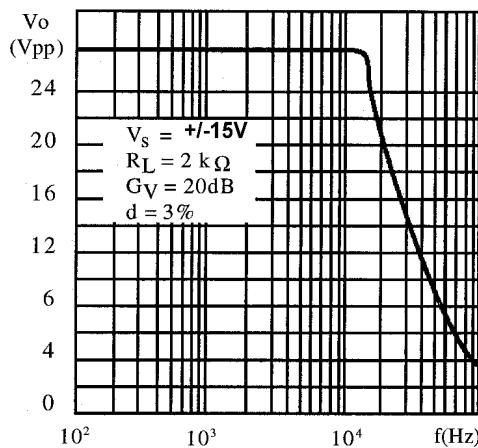
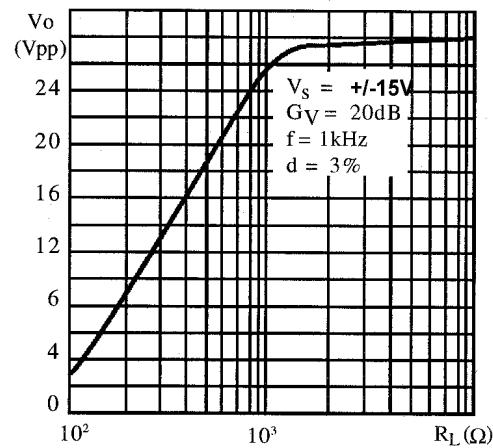
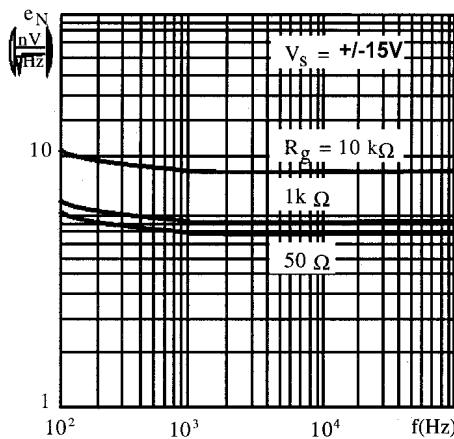
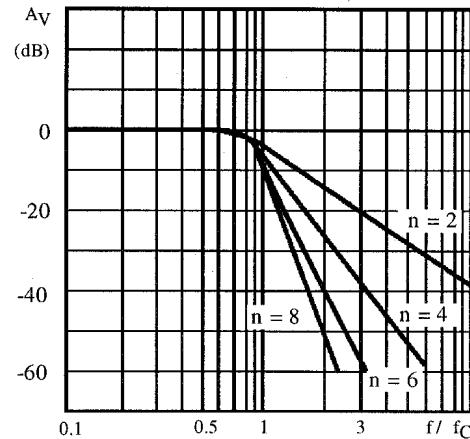
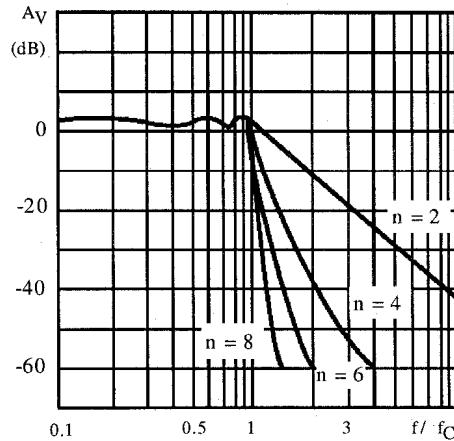
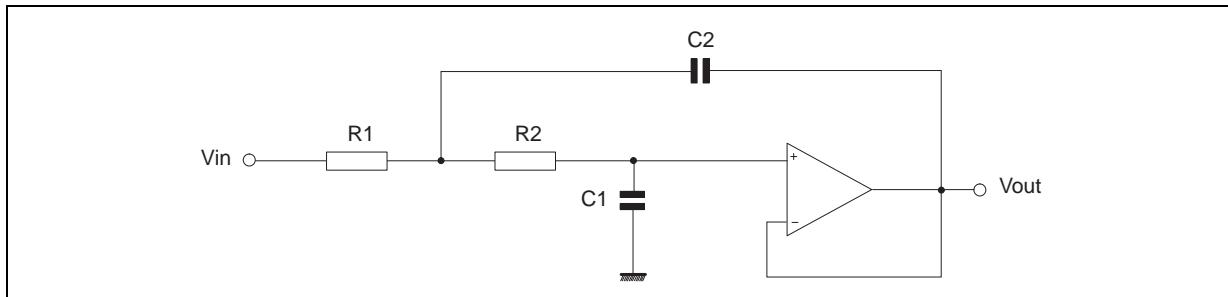
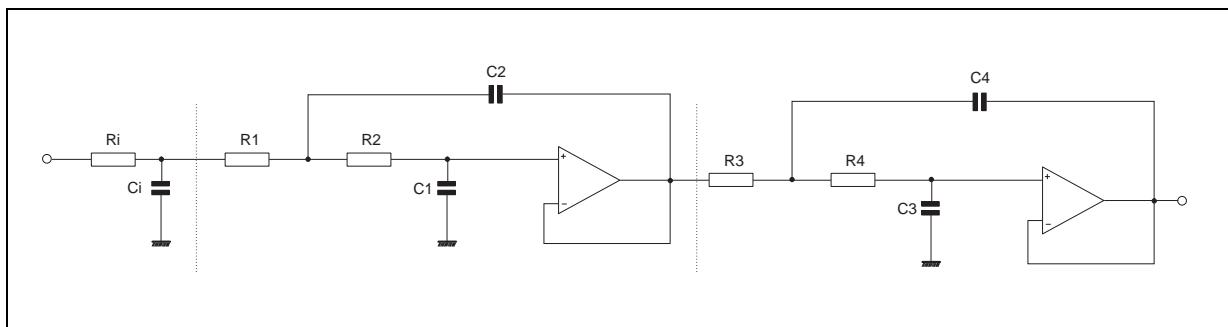
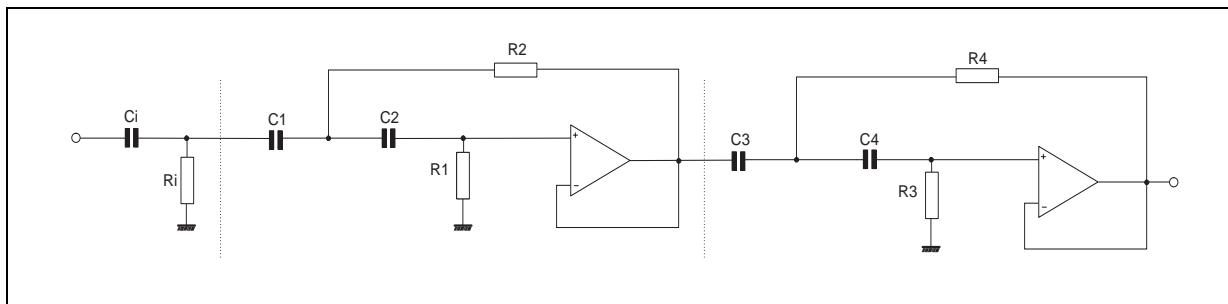
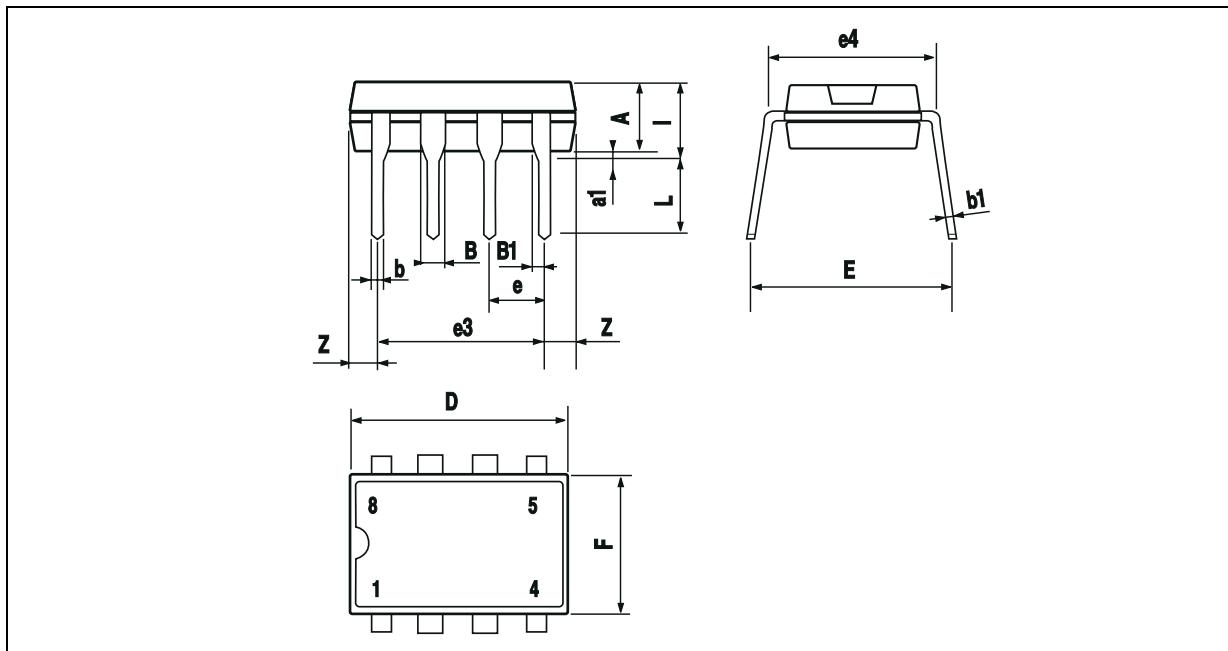
Figure 7 : Large Signal Frequency Response**Figure 8 : Output Voltage Swing versus Load Resistance****Figure 9 : Total Input Noise versus Frequency****Figure 10 : Amplitude Response****Figure 11 : Amplitude Response (±1dB ripple)**

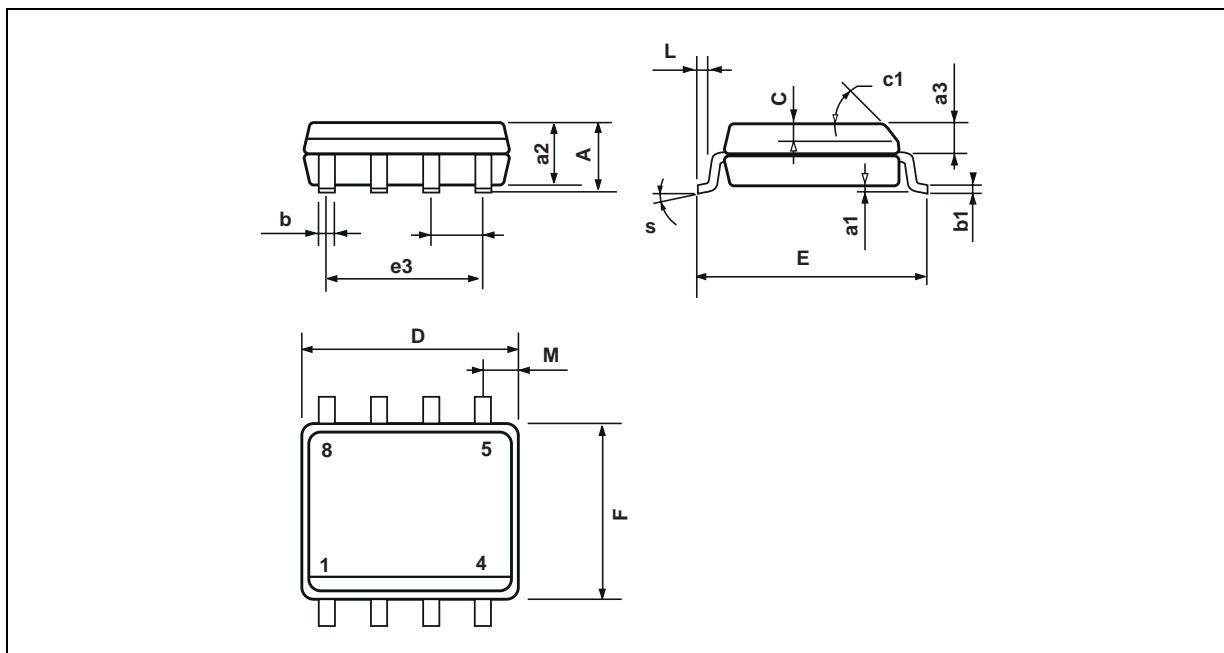
Figure 12 : Filter Configuration**Figure 13 : 5th Order Low-pass Filter (Butterworth) with Unity Gain configuration****Figure 14 : 5th Order High-pass Filter (Butterworth) with Unity Gain configuration**

PACKAGE MECHANICAL DATA
8 PINS - PLASTIC DIP



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		3.32			0.131	
a1	0.51			0.020		
B	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D		10.92				0.430
E	7.95		9.75	0.313		0.384
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			6.6			0.260
i			5.08			0.200
L	3.18		3.81	0.125		0.150
Z			1.52			0.060

PACKAGE MECHANICAL DATA
8 PINS - PLASTIC MICROPACKAGE (SO)



Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
a3	0.65		0.85	0.026		0.033
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.020
c1	45° (typ.)					
D	4.8		5.0	0.189		0.197
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.150		0.157
L	0.4		1.27	0.016		0.050
M			0.6			0.024
S	8° (max.)					

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